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Vishay Siliconix

Automotive P-Channel 30 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	-30			
$R_{DS(on)}$ (Ω) at $V_{GS} = -10 \text{ V}$	0.175			
$R_{DS(on)}$ (Ω) at $V_{GS} = -4.5 \text{ V}$	0.300			
I _D (A)	-3			
Configuration	Single			
Package	SC-70			

FEATURES

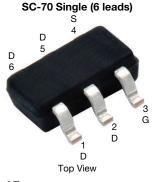
- TrenchFET® power MOSFET
- AEC-Q101 qualified c
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





COMPLIANT HALOGEN FREE





Marking Code: 9E

G o —	S
P-Channel MOSFET	D

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V_{DS}	-30	V	
Gate-Source Voltage		V_{GS}	± 20	V	
Continuous Drain Current	T _C = 25 °C		-3		
Continuous Drain Current	T _C = 125 °C	I _D	-1.8		
Continuous Source Current (Diode Conducti	on)	I _S	-3.7	Α	
Pulsed Drain Current ^a	I _{DM}	-12			
Single Pulse Avalanche Current	ngle Pulse Avalanche Current		-6		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	1.8	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	р	3	W	
waxiinum rower bissipation 4	T _C = 125 °C	P_{D}	1	vV	
Operating Junction and Storage Temperatur	T _J , T _{stq}	-55 to 175	°C		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^b		130	°C/W	
unction-to-Foot (Drain)		R _{thJF}	50	G/VV	

Notes

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. When mounted on 1" square PCB (FR4 material).
- c. Parametric verification ongoing.



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PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = -250 μA	-1	-1.5	-2	V
Gate-Source Leakage	I _{GSS}	V _{DS} =	0 V, V _{GS} = ± 20 V	-	-	± 100	nA
		$V_{GS} = 0 V$	$V_{DS} = -30 \text{ V}$	-	-	-1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = -30 V, T _J = 125 °C	-	-	-50	μΑ
		V _{GS} = 0 V	V _{DS} = -30 V, T _J = 175 °C	-	-	-150	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = -10 V	$V_{DS} \le -5 \text{ V}$	-5	-	-	Α
		V _{GS} = -10 V	I _D = -2 A	-	0.125	0.175	Ω
Drain-Source On-State Resistance a	R _{DS(on)}	V _{GS} = -10 V	I _D = -2 A, T _J = 125 °C	-	-	0.252	
Drain-Source On-State Resistance		V _{GS} = -10 V	I _D = -2 A, T _J = 175 °C	-	-	0.294	
		V _{GS} = -4.5 V	I _D = -1.6 A	-	0.230	0.300	
Forward Transconductance b	9 _{fs}	$V_{DS} = -10 \text{ V}, I_D = -2 \text{ A}$		-	3	-	S
Dynamic ^b		_					
Input Capacitance	C _{iss}			=	164	205	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	$V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$	-	44	55	pF
Reverse Transfer Capacitance	C _{rss}			-	28	35	
Total Gate Charge c	Qg			-	4.2	6.5	
Gate-Source Charge c	Q _{gs}	$V_{GS} = -4.5 \text{ V}$	$V_{DS} = -15 \text{ V}, I_{D} = -2.2 \text{ A}$	-	0.7	-	nC
Gate-Drain Charge ^c	Q _{gd}			-	1	-	
Gate Resistance	R_g	f = 1 MHz		4.5	12.5	18.5	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	5	8	
Rise Time ^c	t _r	V_{DD} = -15 V, R_L = 15 Ω $I_D \cong$ -1 A, V_{GEN} = -10 V, R_g = 1 Ω		-	8	12	
Turn-Off Delay Time ^c	t _{d(off)}			-	11	17	ns
Fall Time ^c	t _f			-	8	12	
Source-Drain Diode Ratings and Chara	acteristics ^b						
Pulsed Current ^a	I _{SM}			-	-	-12	Α
Forward Voltage	V_{SD}	I _F = -1.2 A, V _{GS} = 0 V		1	-0.85	-1.2	V

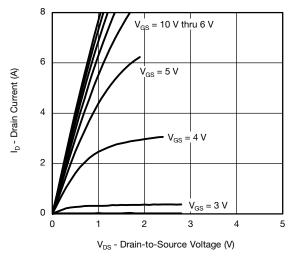
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

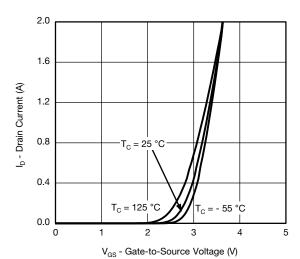
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



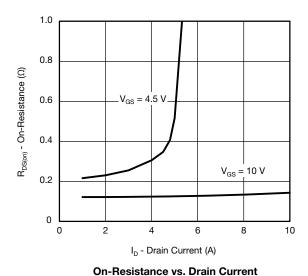
TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Output Characteristics

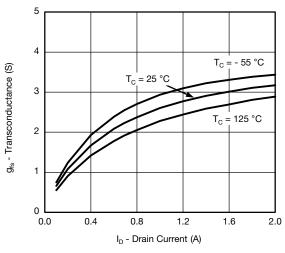


Transfer Characteristics

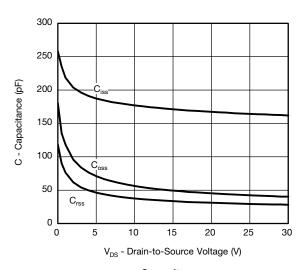


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Transfer Characteristics

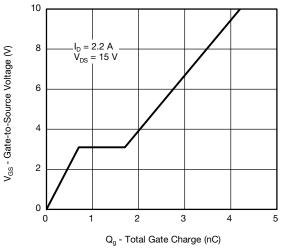


Transconductance

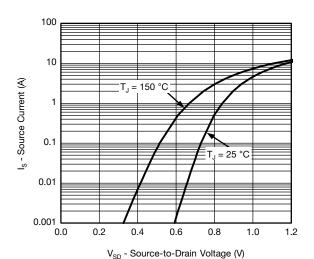




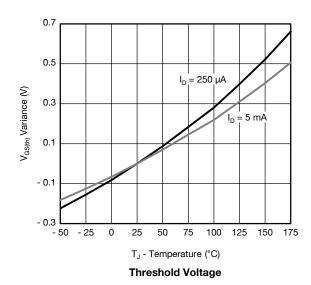
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

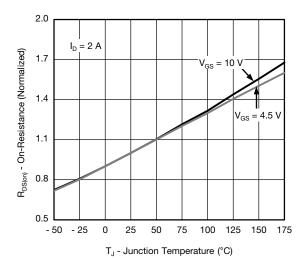


Gate Charge

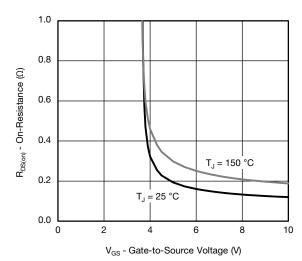


Source Drain Diode Forward Voltage

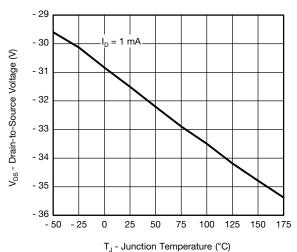




On-Resistance vs. Junction Temperature



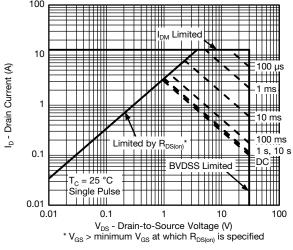
On-Resistance vs. Gate-to-Source Voltage



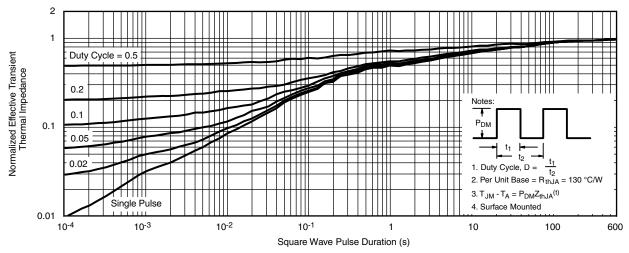
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



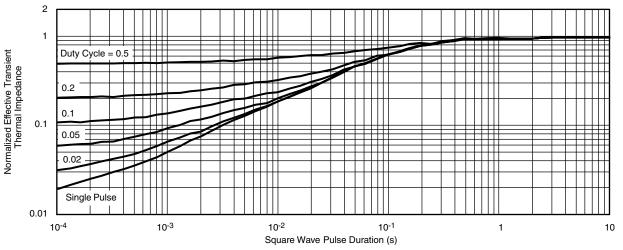
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Foot (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67048.





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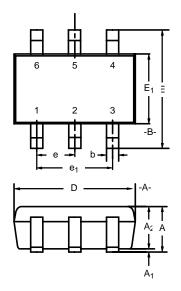
REVISION HISTORY a				
REVISION	DATE	DESCRIPTION OF CHANGE		
С	03-Dec-15	Changed R _g minimum		

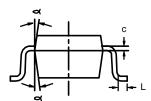
Note

a. As of April 2014



SC-70: 6-LEADS





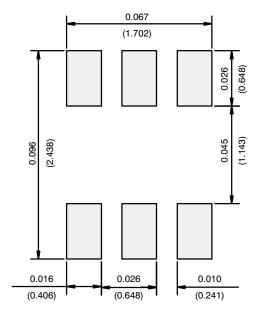
	MILLIMETERS			I	NCHE	S
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.90	_	1.10	0.035	_	0.043
A_1	_	-	0.10	-	_	0.004
A ₂	0.80	_	1.00	0.031	_	0.039
b	0.15	_	0.30	0.006	_	0.012
С	0.10	_	0.25	0.004	_	0.010
D	1.80	2.00	2.20	0.071	0.079	0.087
Е	1.80	2.10	2.40	0.071	0.083	0.094
E ₁	1.15	1.25	1.35	0.045	0.049	0.053
е	0.65BSC				0.026BSC	;
e ₁	1.20	1.30	1.40	0.047	0.051	0.055
L	0.10	0.20	0.30	0.004	0.008	0.012
4	7°Nom				7°Nom	
ECN: S-03946—Rev. B, 09-Jul-01 DWG: 5550						

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RECOMMENDED MINIMUM PADS FOR SC-70: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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